



BAS20DW-BAS21DW

SURFACE MOUNT LOW LEAKAGE DIODE

Features

- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automated Insertion
- High Reverse Breakdown Voltage
- Low Leakage Current
- Lead Free By Design/RoHS Compliant (Note 3)
- "Green" Device (Notes 4 and 5)

Mechanical Data

- Case: SOT-363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.003 grams (approximate)

SOT-363



TOP VIEW

Maximum Ratings $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic	Symbol	BAS20DW	BAS21DW	Unit	
Repetitive Peak Reverse Voltage		V _{RRM}	200	250	V
Working Peak Reverse Voltage DC Blocking Voltage		V _{RWM} V _R	150	200	V
RMS Reverse Voltage		V _{R(RMS)}	106	141	V
Forward Continuous Current	I _{FM}	400		mA	
Average Rectified Output Current	lo	20	mA		
Non-Repetitive Peak Forward Surge Current	I _{FSM}	2.5 0.5		A	
Repetitive Peak Forward Surge Current	I _{FRM}	62	25	mA	

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	PD	200	mW
Thermal Resistance Junction to Ambient Air (Note 1)	$R_{ heta JA}$	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic			Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 2)	BAS20DW BAS21DW	V _{(BR)R}	200 250		V	I _R = 100μA
Forward Voltage		V _F	_	1.0 1.25	V	I _F = 100mA I _F = 200mA
Reverse Current @ Rated DC Blocking Voltage (Note 2)		I _R	_	100 15	nA μA	$T_{j} = 25^{\circ}C$ $T_{j} = 100^{\circ}C$
Total Capacitance		CT		5.0	pF	$V_{R} = 0, f = 1.0MHz$
Reverse Recovery Time		t _{rr}	_	50	ns	$I_{F} = I_{R} = 30 \text{mA},$ $I_{rr} = 0.1 \times I_{R}, R_{L} = 100\Omega$

1. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

2. Short duration pulse test used to minimize self-heating effect.

3. No purposefully added lead.

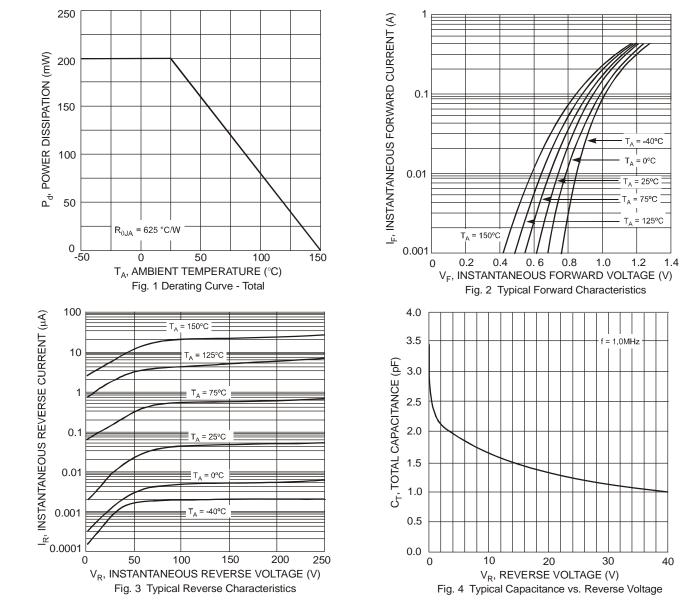
5. Product manufactured with Date Code UO (week 40, 2007) and newer are built with Green Molding Compound. Product manufactured prior to Date Code UO are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

Notes:

^{4.} Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.

BAS20DW-BAS21DW





Ordering Information (Note 6)

Part Number	Case	Packaging
BAS20DW-7	SOT-363	3000/Tape & Reel
BAS21DW-7	SOT-363	3000/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

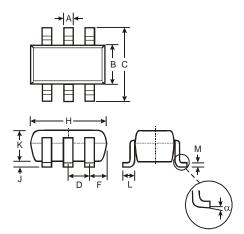
Marking Information

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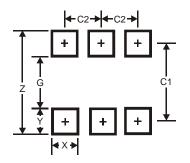


Package Outline Dimensions



SOT-363					
Dim	Min	Max			
Α	0.10	0.30			
В	1.15	1.35			
С	2.00	2.20			
D	0.65 Typ				
F	0.40	0.45			
H	1.80	2.20			
J	0	0.10			
ĸ	0.90	1.00			
L	0.25	0.40			
М	0.10	0.22			
α	0°	8°			
All Di	mensions	in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.5
G	1.3
Х	0.42
Y	0.6
C1	1.9
C2	0.65

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